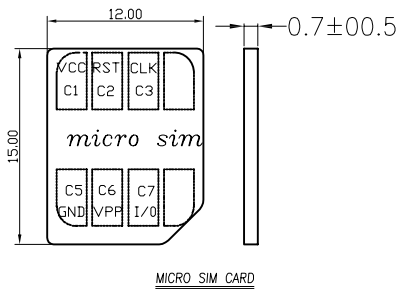
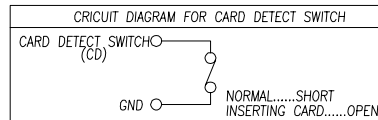


PCB 焊盘区
 下沉定位区
 RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE ±0.05



SIM pin assignment	
PIN#	Name
C1	VCC 供电电压
C2	RST 重置
C3	CLK 时钟
C5	GND 接地
C6	VPP 程序电压
C7	I/O 输入输出



Specification

MATERIAL:

Insulator: High Temperature Thermoplastic, UL 94V-0.
 Contact: Copper Alloy
 SHELL: SUS

PLATING:

Contact: Plated 50u" Ni Overall Contact Au IU
 Shell: Plated 50u" Ni Overall
 Plated Iu/Au Selective Contact Area

Electrical:

Current Rating : 0.5mA AC/DC max.
 Voltage Rating : 125V AC/DC
 Ambient Temperature Range :-20° C +60° C
 Storage Temperature Range :-40° C +70° C
 Ambient Humidity Range :95% R.H. Max.
 Contact Resistance:100m Ω
 Insulation Resistance:1000M Ω
 产品耐温温度: 260° C - 0.34.70 - 0.34.70±5 C
 Mating Cycles:3000min Insertions

JB Bossie (博锡)

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X." ±2' X.X" ±0.5'	DRAWN BY :	DATE :	PART NAME: 自弹式 MicroSIM卡卡座 6P	
	CHECKED BY:	DATE :	PART NO.	BX-SIM-1.35H6PJ
UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY:	DATE :	MOLD NO.	
			DRAW NO:	
			SHEET NO.	1 OF 1